

Application Number Information

Application Number: **10/598124**

Assignments

Filing or 371(c) Date: **08/18/2006** eDan

Effective Date: **08/18/2006**

Application Received: **08/18/2006**

Patent Number:

Issue Date: **00/00/0000**

Date of Abandonment: **00/00/0000**

Attorney Docket Number: **P30245**

Status: **19 /APPLICATION UNDERGOING PREEEXAM PROCESSING** Status Date: **08/18/2006**

Confirmation Number: **1323**

Examiner Number: **00000 /**

Group Art Unit: **1742** **IFW Madras**

Class/Subclass: **148/023.000**

Lost Case: **NO**

Interference Number:

Unmatched Petition: **NO**

L&R Code: Secrecy Code: **1**

Third Level Review: **NO** Secrecy Order: **NO**

Title of Invention: **SOLDER COMPOSITION AND METHOD OF BUMP FORMATION
THEREWITH**

| | | | | | | |
|----------|---------------|---------------|---------------|----------------|---------------|----------|
| Bar Code | PALM Location | Location Date | Charge to Loc | Charge to Name | Employee Name | Location |
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[Petition Info](#)

[Atty/Agent Info](#)

[Continuity/Reexam](#)

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Search Another: Application# or Patent#
PCT / / or PG PUBS #
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